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Equinix to Accelerate and Simplify Liquid Cooling Deployments to Power Enterprise Al Workloads

Supports direct-to-chip liquid cooling in more than 45 metros across all three regions to power compute-intensive workloads like artificial intelligence

REDWOOD CITY, Calif., Dec. 11, 2023 /PRNewswire/ -- <u>Equinix, Inc.</u> (Nasdaq: EQIX), the world's digital infrastructure company®, today announced plans to expand support for advanced liquid cooling technologies—like direct-to-chip—to more than 100 of its International Business Exchange® (IBX®) data centers in more than 45 metros around the world. This builds on Equinix's existing offering that supports liquid-to-air cooling, through inrack heat exchangers, at nearly every IBX today. This expansion will enable more businesses to use the most performant cooling technologies for the powerful, high-density hardware that supports compute-intensive workloads like artificial intelligence (AI).

"We have seen an increase in demand for data-intensive and high-compute applications like AI," said Sean Graham, Research Director, Cloud to Edge Datacenter Trends at IDC. "The hardware required to run these new applications is pushing up densities inside data centers and can no longer be efficiently cooled by traditional techniques. We are seeing a growing demand for liquid-cooled solutions from enterprises, and it is essential that data center providers, like Equinix, can support this next generation of cooling solutions."

With commercialized support of direct-to-chip liquid cooling in more than 45 metros including London, Silicon Valley, Singapore, and Washington D.C.—customers can deploy advanced liquid cooling solutions against mission-critical needs in the markets that matter most to them. Equinix provides direct access to the ecosystem of partners and providers of Platform Equinix[®]. By continuing this approach Equinix is committed to empowering digital leaders with the ability to evolve their next-generation liquid-cooled designs.

"Liquid cooling is revolutionizing how data centers cool powerful, high-density hardware that supports emerging technologies, and Equinix is at the heart of that innovation," said Tiffany Osias, Vice President of Global Colocation, Equinix. "We have been helping businesses with significant liquid-cooled deployments across a range of deployment sizes and densities for years. Equinix has the experience and expertise to help organizations innovate data center capacity to support the complex, modern IT deployments that applications like AI require."

Equinix supports major liquid cooling technologies, including direct-to-chip and rear-door heat exchangers so that customers can take advantage of the most efficient solutions. Additionally, Equinix is offering a vendor-neutral approach to enable customers to use their preferred hardware provider in their deployments.

Direct-to-chip is a unique approach that involves a cold plate sitting on top of the chip inside the server. The cold plate is enabled with liquid supply and return channels, allowing technical cooling fluid to run through the plate, drawing heat away from the chip. This allows direct-to-chip-enabled servers to be installed in a standard IT cabinet just like legacy aircooled equipment, even while being cooled in an innovative way. Rear-door heat exchangers use a cooling coil and fans to capture heat from air cooled IT equipment. They are mounted directly onto customer cabinets, so are able to manage higher cooling loads than conventional cooling.

"Liquid cooling was front and center in our development of the Open19 V2 specification. The goal of the Open19 project, which operates under the Linux Foundation, was to create an open standard that can fit any 19" rack for server, storage, and networking. The project enables digital leaders to use hardware from a diverse set of vendors efficiently and sustainably in any datacenter environment. Equinix's technology and vendor neutral approach to liquid cooling is a mechanism to remove the friction of deploying advanced liquid cooling solutions in enterprise data centers." - My Truong, SSIA Chairperson and Field CTO for Equinix.

"For next-generation chips and other AI infrastructure, traditional air-cooling approaches simply will not get the job done on their own. Liquid-cooling can offer better performance while saving energy and helping data centers operate more efficiently. Equinix's state-of-the-art data centers provide an ideal environment for customers to deploy cutting edge CoolIT Systems liquid-cooling technologies, ensuring optimal resiliency, energy efficiency, and reliability for mission-critical digital infrastructure." - Steve Walton, CEO, CoolIT Systems Inc.

"Effective cooling solutions are essential for data centers to keep up with the rapidly evolving world of computing. We believe that liquid cooling has a critical role to play in supporting the next wave of digital infrastructure. ZutaCore has been partnering with Equinix at its Co-Innovation Facility and Equinix Metal deployments to help develop, operate, and test the next generation of liquid cooling solutions at scale. We're excited to see Equinix expand the number of liquid cooling enabled data centers as we continue to optimize customer workloads with waterless liquid cooling to drive towards a zero-emissions data industry." – Erez Freibach, Co-founder and CEO, ZutaCore

Additional Resources

- <u>3 Trends Driving Liquid Cooling for Data Centers</u>
- Exploring Liquid Cooling for Next-Gen Business Applications
- Liquid Cooling In Action—On Our Own Production Servers

About Equinix

Equinix (Nasdaq: EQIX) is the world's digital infrastructure company[®]. Digital leaders harness Equinix's trusted platform to bring together and interconnect foundational infrastructure at software speed. Equinix enables organizations to access all the right places, partners and possibilities to scale with agility, speed the launch of digital services, deliver world-class experiences and multiply their value, while supporting their sustainability goals.

Forward-Looking Statements

This press release contains forward-looking statements that involve risks and uncertainties. Actual results may differ materially from expectations discussed in such forward-looking statements. Factors that might cause such differences include, but are not limited to, risks to our business and operating results related to the COVID-19 pandemic; the current inflationary environment; foreign currency exchange rate fluctuations; increased costs to procure power and the general volatility in the global energy market; the challenges of acquiring, operating and constructing IBX[®] and xScale[®] data centers and developing, deploying and delivering Equinix products and solutions; unanticipated costs or difficulties relating to the integration of companies we have acquired or will acquire into Equinix; a failure to receive significant revenues from customers in recently built out or acquired data centers; failure to complete any financing arrangements contemplated from time to time; competition from existing and new competitors; the ability to generate sufficient cash flow or otherwise obtain funds to repay new or outstanding indebtedness; the loss or decline in business from our key customers; risks related to our taxation as a REIT and other risks described from time to time in Equinix filings with the Securities and Exchange Commission. In particular, see recent and upcoming Equinix quarterly and annual reports filed with the Securities and Exchange Commission, copies of which are available upon request from Equinix. Equinix does not assume any obligation to update the forward-looking information contained in this press release.



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